AMENDMENTS TO THE SPECIFICATION:

Page 1, replace the last paragraph (bridging pages 1 and 2), as follows:

The current flash disk has a substrate soldered with a plurality of electronic components and a flash memory for providing a data storage capacity. The flash disk is small [[in]] compared with other storage media, however, under the present intense demand for devices that are smaller, thinner, lighter and so on, it is desired desirable to further miniaturize the flash disk and increase [[the]] its portable convenience. Unfortunately, it is difficult to achieve such a purpose because a height generated between the electronic components and the substrate by soldering points needs an appropriate thickness of a case for housing the substrate and the electronics. Therefore, it is desirable to provide an improved portable storage device to mitigate and/or obviate the aforementioned problems.

Page 3, replace paragraph 3, as follows:

With reference to FIG. 1, there is shown a micro-storage device having a substrate 1 and a metal case 3. The substrate 1 has a circuit board (circuit board part) 12 and a connector (connecting head) 11 extended from the circuit board 12. A plurality of contacts 111 is arranged on the connector 11, i.e., the contacts are formed directly onto the substrate 1 by layout to electrically connect to an external electronic apparatus (not shown). The circuit board 12 is mounted with at least one electronic component 21 by an advance package technique.